date: 2003/05/26

# RENESAS TECHNICAL UPDATE

Classification of Production	P	Packages		No	TN-PKG-086C/E		Rev.	3
ТНЕМЕ		fication of changing over to JEDEC tray QFP1420,2020 & TQFP1414)	<u> </u>		Classification of Information 1. Spec change 2. Supplement of Docume 3. Limitation of Use 4. Change of Mask 5. Change of Production I			
	All dev	All devices to which the following packages are applied;  QFP1420 : FP-128,128B  QFP2020 : FP-88,112,112B  TQFP1414 : TFP-64,80,80F,100,100B,120				term of validity		
PRODUCT NA	QFP142 QFP202			Reference Documents			permanent	
this changes 1. Tray	change the shi ge,the number	oment tray from the old Hitachi (Semiconductor group) custo of devices loaded in a tray, the pocket pitch, and the heat-proge in July,2003)			the JEI	DEC specificati	on. Accor	ding to
Package		Before change		A	fter ch	nange		
<u>QFP1420</u> FP-128 FP-128B	Outline	Pockets for Vacuum cf (Hole-less pockets)						Pockets for vacuum chuck (Hole-less pockets)
	Number of devices	5×10=50pcs/tray		6>	<12=72p	cs/tray		
	Tray type	PT844B(130°C heat-proof) PT844C(150°C heat-proof)		PTA63C(150°C heat-proof)				
OFP2020 FP-88 FP-112		Pockets for						Pockets for vacuum chuck
FP-88	Outline	vacuum ch (Hole-less pockets)	ıck					(Hole-less pockets)
FP-88	Outline  Number of devices	vacuum chi (Hole-less	ıck	5>	×12=60p	cs/tray		
FP-88 FP-112		vacuum ch (Hole-less pockets)	ick			cs/tray °C heat-proof)		
FP-88 FP-112 FP-112B TOFP1414 TFP-64 TFP-80 TFP-80F TFP-100	Number of devices	vacuum ch (Hole-less pockets)  4×10=40pcs/tray		PTA6	4C(150	•		
FP-88 FP-112 FP-112B TOFP1414 TFP-64 TFP-80 TFP-80F	Number of devices  Tray type	vacuum ch (Hole-less pockets)  4×10=40pcs/tray  PT872CM(150°C heat-proof)  Pockets for vacuum ch (Hole-less pockets)		PTA6	4C(150	C heat-proof)		Pockets for vacuum chuck (Hole-less
FP-88 FP-112 FP-112B TOFP1414 TFP-64 TFP-80 TFP-80F TFP-100 TFP-100B	Number of devices  Tray type  Outline	vacuum ch (Hole-less pockets)  4×10=40pcs/tray  PT872CM(150°C heat-proof)  Pockets for vacuum ch (Hole-less pockets)		PTA6	4C(150	C heat-proof)		Pockets for vacuum chuck (Hole-less

### 2. Cause of change

To standardize the tray specification and to reduce the environmental load by increasing the number of devices loaded in a tray.

#### 3. Change time

We will apply the new tray ( JEDEC tray ) to the devices produced in July, 2003.

Due to the stock control, some devices will be shipped in an old tray (Hitachi tray) for a while. We hope your understanding and approval.

As to the devices shipped in a JEDEC tray, the letter "J" is printed on the first column of an inner box label, and the "JEDEC SPEC TRAY" indication is printed on the front side of an inner box for a while.

In addition, for the devices which have already been shipped in a JEDEC tray, the "JEDEC SPEC TRAY" indication is printed on the front side of an inner box for a while.

## • Indication of inner box label

The letter "J" is printed on the first column of an inner box label



\* The same label is attached on the moisture-proof bag.

\* We plan to indicate the letter

"J" for approximately one year.

## Indication of inner box

The indication of "JEDEC SPEC TRAY" is printed in black on the front side of an inner box.

